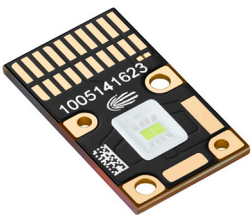


PTM-40X-CG

Projection

Converted Green LED



Features

- Phosphor Converted Green LED with 4.0 mm² emitting area designed for display or other high performance applications
- Complement with PTM-40X Red-Amber, Blue and Blue Pump for best projection brightness and color gamut
- Dominant wavelength: Converted Green 555 nm
- LED die precision mounted on Ultra low thermal resistance MC-PCB package
- Thermistor pad allows option for precise thermal management
- Supports up to 12 A for highest brightness
- Chipset array in series enabling lower drive current
- Windowless package allows for closer collection optics and brighter system solutions
- LED emitting area optimized for micro-display diagonal sizes ranging from 0.45" to 0.55"



Applications

- Specifically engineered for ultra portable ("Pico") front projectors, head-up projection displays, and hybrid projectors
- Suitable for DLP™, LCoS and HTPS /3LCD microdisplays

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Ordering Information

Ordering Part Numbers¹

Color	Luminous Flux ²		Ordering Part Number ³
	Min. Flux Bin	Min. Flux	
Converted Green	2G	5150 lm	PTM-40X-CG-L34-MPG
	2H	5430 lm	PTM-40X-CG-L34-MPH

Part Number Nomenclature

PTM	40X	CG	L34	<Bin kit>
Product Family	Chip Area	Color	Package Configuration	Bin Kit ^{4,5}
PTM: Projection Technology Multi-Die	40: 4 mm ² X: Isolated	CG: Converted Green	L34: No Connector, Core board, Windowless (See Mechanical Drawing section)	Refer to ordering part numbers in this document

Note:

- Ordering part numbers represent bin kits (group of bins that are shippable for a given ordering part number)
- Flux Bin listed is minimum bin shipped, higher bins may be included at Luminus' discretion.
- Ordering Part number is default to L34 package configuration.
- Individual flux bins are not orderable.
- See Bin Kit and Flux / Power bin definitions on page 3.



Binning Structure

Flux Bins^{1,2}

Color	Luminous Flux Bin ³	Binning @ 8.0 A, T _j = 25°C ⁴	
		Minimum Flux (lm)	Maximum Flux (lm)
Converted Green	2G	5150	5430
	2H	5430	5730
	2J	5730	6030
	2K	6030	6350
	2L	6350	6740

Note:

1. Luminus maintains a +/- 6% tolerance on flux measurements.
2. Products are production tested then sorted and packed by bin.
3. Individual bins are not orderable. Please refer to the Product Ordering information page for a list of orderable bin kits.
4. Product test condition: 8.0 A, 20 ms single pulse, 25°C = heat sink temperature = T_{hs} = T_j.



Absolute Maximum Ratings

	Symbol	Values	Unit
Reverse Drive Current ^{1,2}	$I_{r\ max}$	0	mA
Forward Current (CW) ^{2,3}	$I_{f\ min}$	0.2	A
	$I_{f\ max\ CW}$	10.0	
Forward Current (Pulsed) ^{3,4} (Frequency > 240Hz, duty cycle < 70%)	$I_{f\ max\ Pulsed}$	12.0	
Forward Surge Current (Pulsed) ^{3,4} (Frequency > 240Hz, duty cycle = 10%, t=1ms)	$I_{surge\ max}$	13.0	A
Storage Temperature	$T_{s\ min}$	-40	°C
	$T_{s\ max}$	100	
Junction Temperature	$T_{j\ max}$	150	°C
ESD sensitivity ANSI/ESDA/JEDEC JS-001 (HBM, Class 3A)	V_{ESD}	4000	V

Note:

1. Reverse Current Operation is not allowed.
2. Product performance and lifetime data is specified at recommended forward drive currents. Sustained operation at or near absolute minimum currents may result in a reduction of device performance and device lifetime compared to recommended forward currents.
3. Sustained operation above maximum currents is not recommended and will result in a reduction of device lifetime compared to specified maximum forward drive currents. Device lifetimes will depend on junction temperature.
4. In pulsed operation, rise time from 10% to 90% of forward current should be larger than 0.5 microseconds.



Device Characteristics

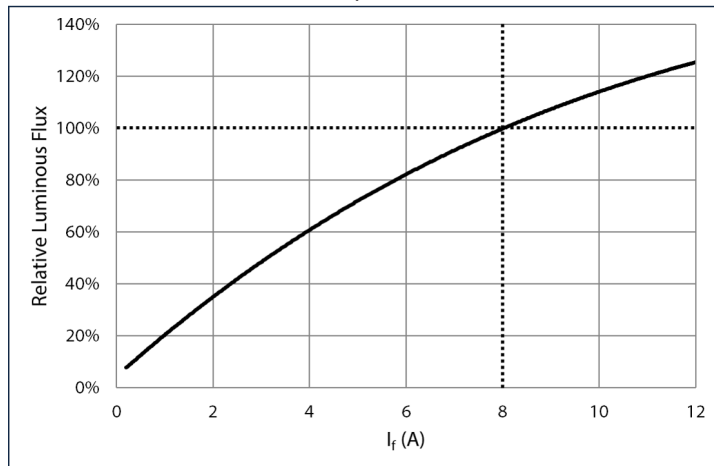
General Characteristics	Symbol	Red Amber	Unit
Active Emitting Area	A_E	4.03	mm ²
Emitting Area Dimension		2.71 x 1.56	mm x mm
Optical and Electrical Characteristics ¹			
Test Pulse Duration		20	ms
Test Peak Drive Current ²	I_f	8.0	A
Peak Luminous Flux ²	Φ_v	6120	lm
Peak Radiometric Flux ²	Φ_r	13.6	W
Forward Voltage	$V_{f \min}$	6.8	V
	V_f	7.0	
	$V_{f \max}$	8.0	
Dominant Wavelength	$\lambda_{d \min}$	545	nm
	λ_d	555	
	$\lambda_{d \max}$	565	
Peak Wavelength	λ_p	520	nm
FWHM- Spectral bandwidth at 50% of Φ_r	$\Delta\lambda_{1/2}$	100	nm
Chromaticity Coordinates, <small>LED factory test</small> ³	CIE x	0.33	
	CIE y	0.56	
Chromaticity Coordinates, <small>after filter</small> ^{3,4}	CIE x _{filtered}	0.31	
	CIE y _{filtered}	0.63	
Thermal Characteristics			
Thermal Resistance (junction to case) real ⁵	$R_{\theta j-c \text{ real}}$	1.10	°C/W
Thermal Resistance (junction to case) electrical ⁵	$R_{\theta j-c \text{ electrical}}$	0.80	°C/W

Note:

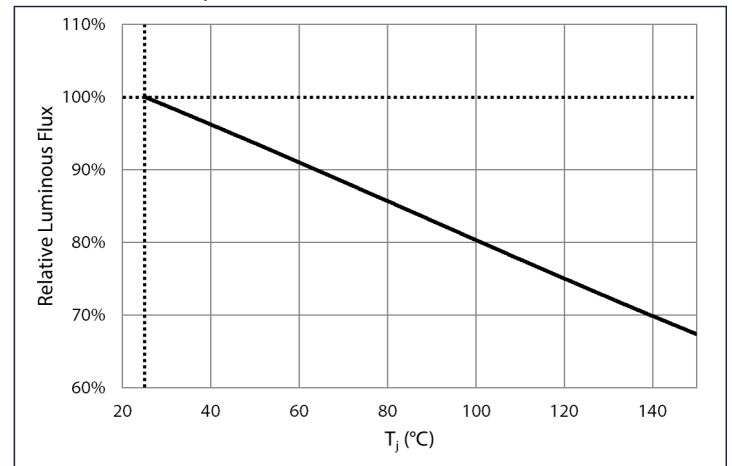
- Characteristics at 8.0 A, 20 ms single pulse, 25°C
- Unless otherwise noted, values listed are typical. All ratings are based on operation with a constant temperature = 25°C = T_{hs} = T_j .
- In CIE 1931 chromaticity diagram coordinates, normalized to X+Y+Z=1.
- Optical filter of 50% cut off range between 580 nm and 600 nm applied in typical projection display engine.
- Measurements are in accordance with JEDEC 51-14.

Relative Luminous Flux

Forward current: $\phi_v(I_f)/\phi_v(8.0\text{ A})$, $T_j = 25^\circ\text{C}$, 20 ms single pulse

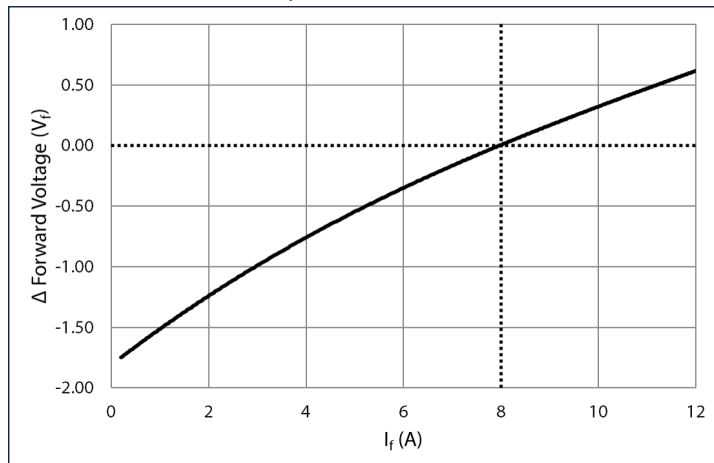


Temperature: $\phi_v(T_j)/\phi_v(25^\circ\text{C})$, $I_f = 8.0\text{ A}$, 20 ms single pulse

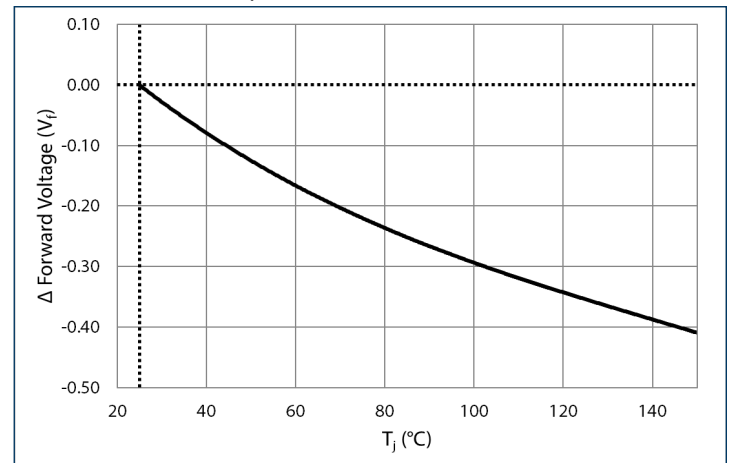


Forward Voltage

Forward current: $V_f = V(I_f)$, $T_j = 25^\circ\text{C}$, 20 ms single pulse

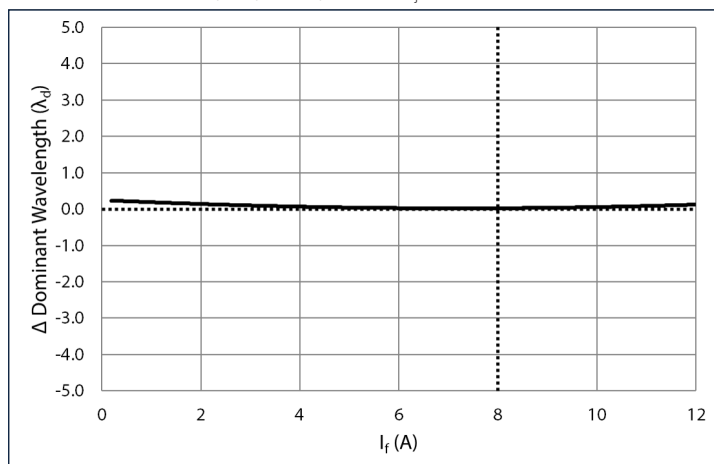


Temperature: $\Delta V_f = V(T_j) - V(25^\circ\text{C})$, $I_f = 8.0\text{ A}$, 20 ms single pulse

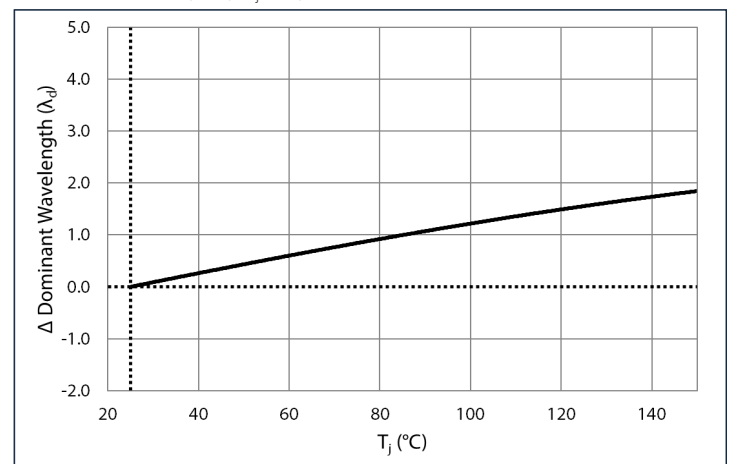


Dominant Wavelength Shift

Forward current: $\Delta\lambda_d = \lambda_d(I_f) - \lambda_d(8.0\text{ A})$, $T_j = 25^\circ\text{C}$, 20 ms single pulse



Temperature: $\Delta\lambda_d = \lambda_d(T_j) - \lambda_d(25^\circ\text{C})$, $I_f = 8.0\text{ A}$, 20ms single pulse

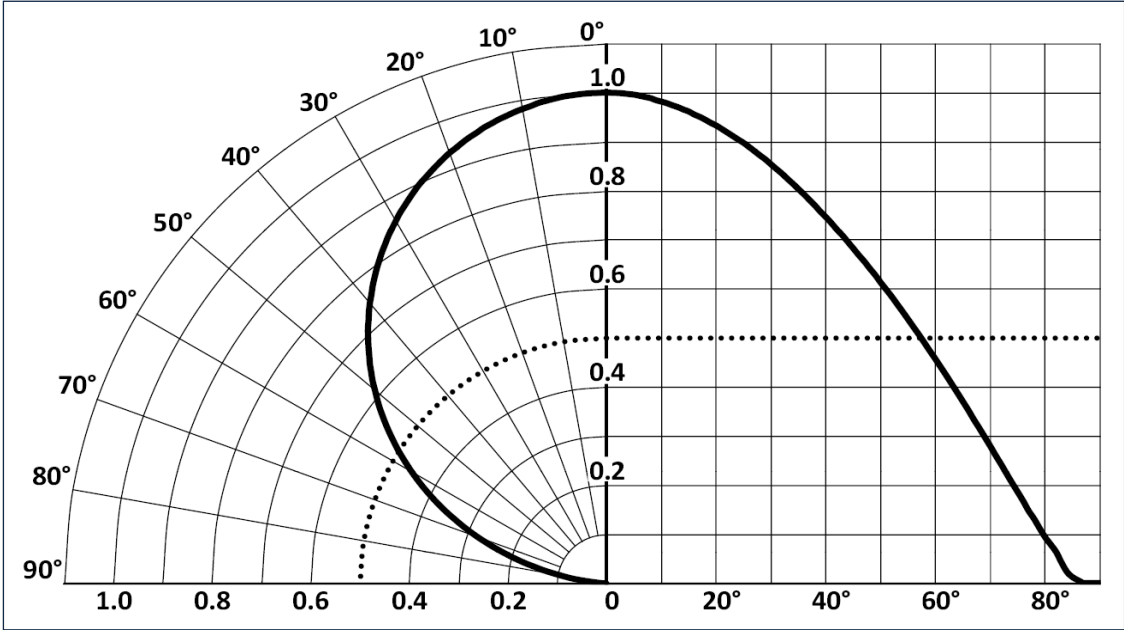




Angular Distribution and Typical Spectrum

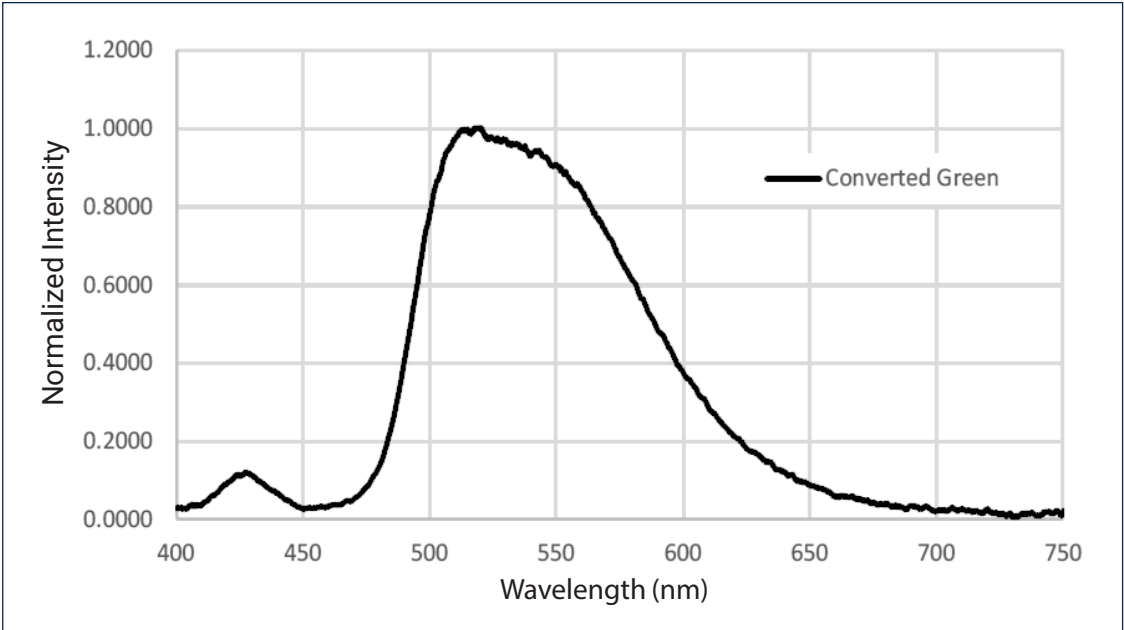
Angular Intensity Distribution¹

$I_{ref} = f(\Phi); T_j = 25^{\circ}\text{C}$



Typical Spectrum²

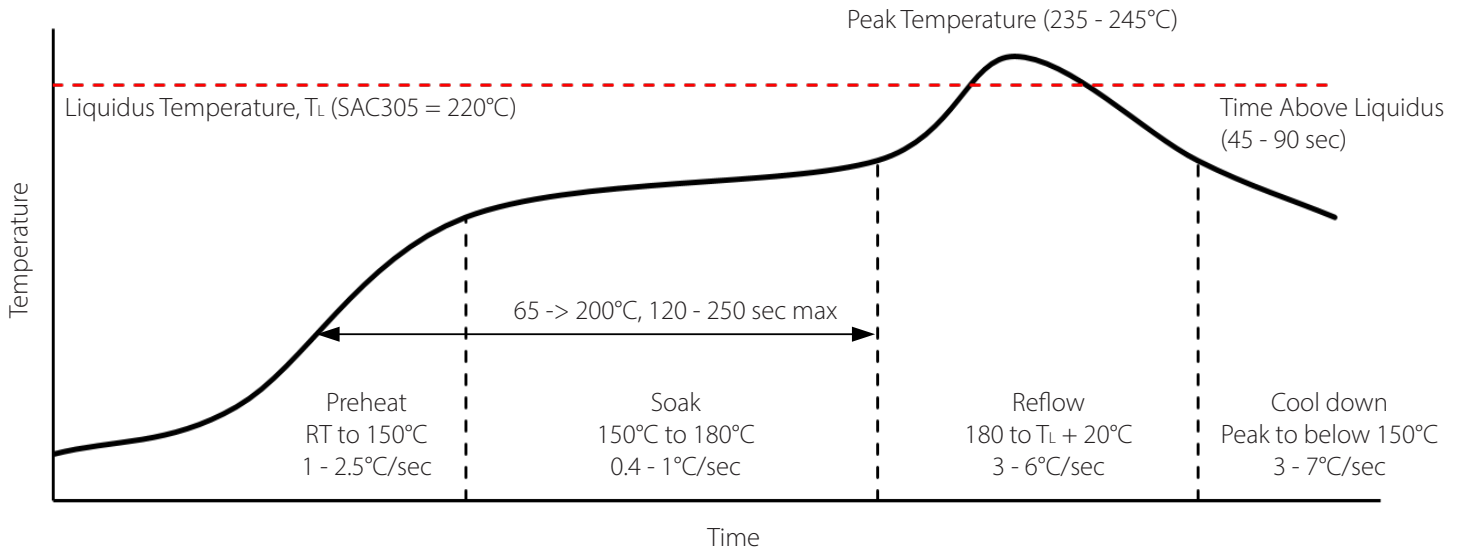
$\Phi_{ref} = f(\lambda); I_f = 8.0\text{ A}; T_j = 25^{\circ}\text{C}$



Note:

1. For any specific device, slight variations may be expected.
2. Typical spectrum at recommended peak drive current. Please contact Luminus to obtain data in Excel format.

Soldering Profile



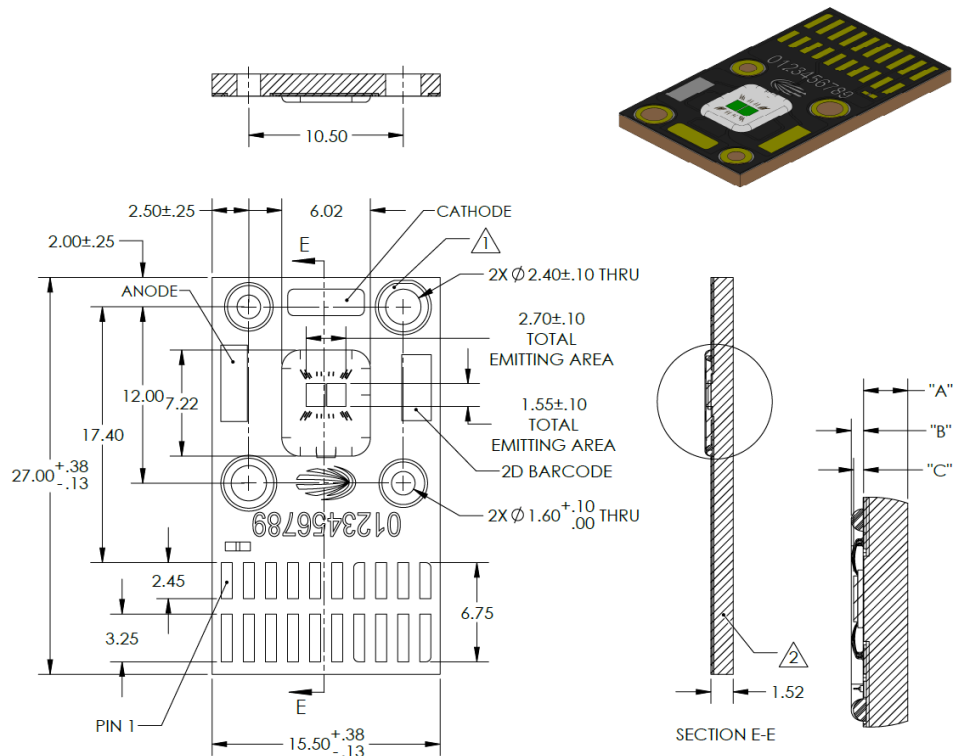
SMT Rework Guideline	Manual Hotplate Reflow	Hot Air Gun Reflow
Heating Time	< 60 sec	
Hotplate Temperature	< 245°C	< 150°C

Note:

- Product complies to Moisture Sensitivity Level 1 (MSL 1).
- The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.
- During the pick and place process, ensure the pick-up tool does not touch any die components.
- Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.
- Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. Temperature is referenced to the center of the PCB.
- Luminus recommends to use the solder paste data sheet information as a starting point in time-temperature process development.
- These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application.
For more information, please refer to:
<https://luminusdevices.zendesk.com/hc/en-us/articles/360060306692-How-do-I-Reflow-Solder-Luminus-SMD-Components->
- For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.

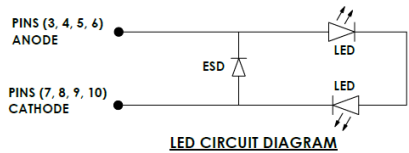
Mechanical Dimensions

DIMENSIONS IN MILLIMETERS



- NOTES:
- 1. METAL SUBSTRATE PLATED AREAS AROUND HOLES ARE COPLANAR WITH CATHODE AND ANODE PADS.
 - 2. METAL SUBSTRATE PLATED AREAS AROUND HOLES ARE ELECTRICALLY CONNECTED TO THE BACKSIDE OF COREBOARD. THEY ARE ELECTRICALLY ISOLATED FROM THE CATHODE, ANODE AND THERMISTOR.

PIN ASSIGNMENT	
THERMISTOR	1,2
ANODE (+)	3,4,5,6
CATHODE (-)	7,8,9,10



DIMENSION NAME	DESCRIPTION	NOMINAL DIMENSION	TOLERANCE
"A"	TOP OF METAL SUBSTRATE TO BACK OF COREBOARD	1.50	±.10
"B"	TOP OF METAL SUBSTRATE TO TOP OF DAM	.42	±.04
"C"	TOP OF METAL SUBSTRATE TO TOP OF EMITTING AREA	.34	±.02

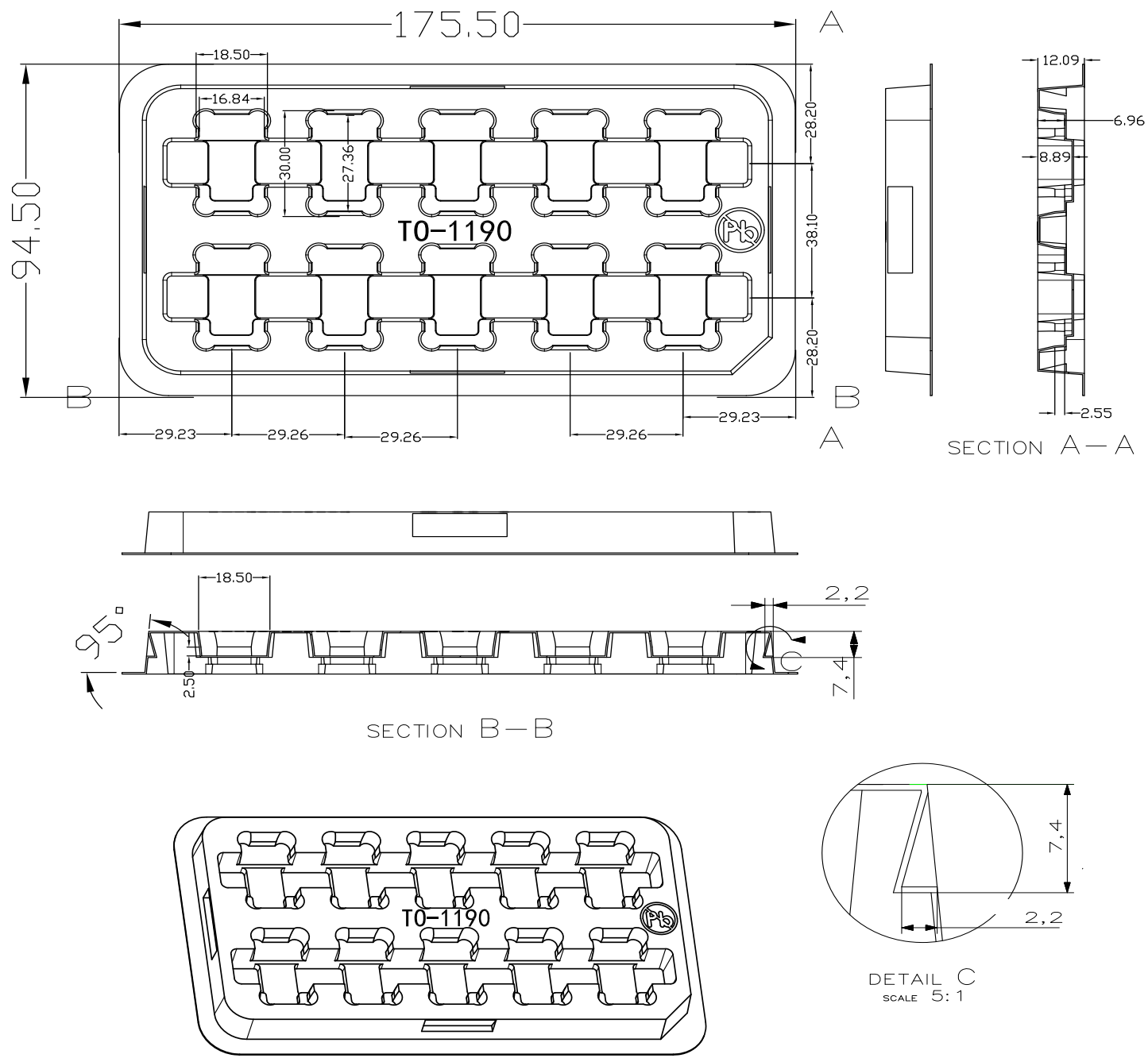
DWG-003091 REV02

Note:

1. Die Tilt: 1° Maximum, Die Rotation: ±1°
2. Contact within silicone dam area is prohibited.
3. Recommended connector: Manufacturer: Tarng-Yu; Part# TU1502WGR-10S-GO-M8-NL-A
4. Recommended female connector: Manufacturer: Tarng-Yu; Part# TU1502HNO-10; contact terminal part#TU1502TGO-GO
5. LED coreboard backside is electrically isolated.
6. LED emitter and wirebond not covered, contact within the silicone dam area is prohibited.



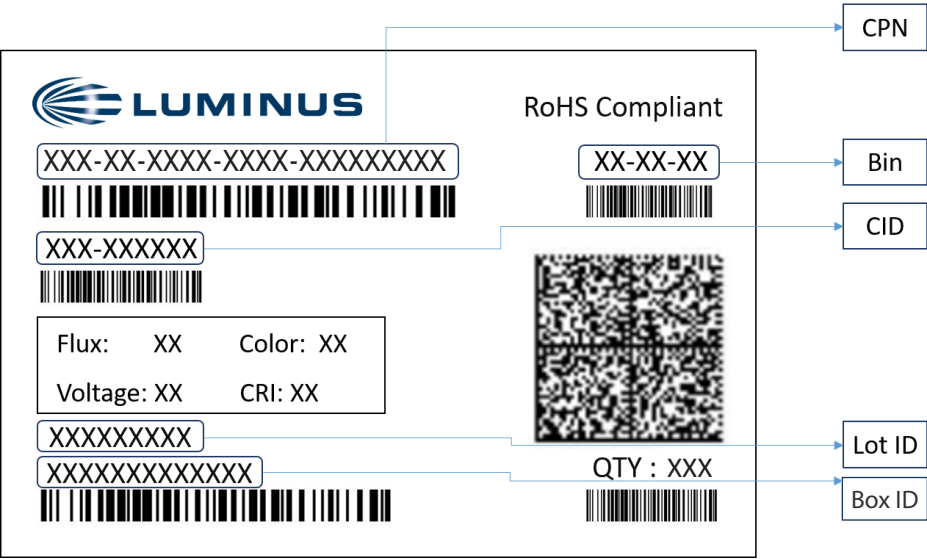
Shipping Tray Outline



Note:
1. For detailed drawing of shipping tray, please refer to document T0-1190, available upon request.



Shipping Label



Label Fields:

- CPN: Luminus ordering part number
- CID: Customer's part number
- QTY: Quantity of devices in pack
- Flux: Bin as defined on page 3
- Voltage: NA
- Color: NA
- CRI: NA

Packing Configuration:

- Stack of 5 trays with 10 devices per tray
- Partial pack or tray may be shipped
- Each pack is enclosed in anti-static bag
- Shipping label is placed on top of each pack



Notes

Static Electricity

This product is sensitive to static electricity, and care should be taken when handling them. Static electricity or surge voltage will damage the LEDs. It is recommended to wear an anti-electrostatic wristband or anti-electrostatic gloves when handling the LEDs. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken to isolate LED processing equipment from potential sources of voltage surges.

Reference: APN-002815 Electrical Stress Damage to LEDs and How to Prevent It

Eye Safety

According to the test specification risk group IEC 62471: 2006-Non-GLS under 8.0 A, this product complies to Risk group 2 (RG2) Moderate risk.

Do not stare at operating lamp, may be harmful to the eyes.

For more information, please refer to: <https://luminusdevices.zendesk.com/hc/en-us/articles/10532958752397>



Revision History

Rev	Date	Description of Change
01	09/30/2024	Initial release
02	02/05/2025	Update description in Absolute Maximum Ratings

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Luminus Devices:](#)

[PTM-40X-CG-L34-MPH](#) [PTM-40X-CG-L34-MPG](#)